

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In application of: ZHU et al.

Attorney Docket No.: LAM1P147/P0675

Application No.: 09/782,185

Examiner: CHEN, Kin-Chan

Filed: February 12, 2001

Group: 1765

Title: UNIQUE PROCESS CHEMISTRY FOR ETCHING ORGANIC LOW-K MATERIALS

<u>CERTIFICATE OF MAILING</u>

I hereby certify that this correspondence is being deposited with the United States Postal Service as First Class Mail to: Box Non-Fed Amendment, Commissioner for Patents, Washington, D.C. 20231 on May 16, 2002.

2.1503.7

Sue Funchess

AMENDMENT A TRANSMITTAL

Box Non-Fee Amendment Commissioner for Patents Washington, D.C. 20231

Sir:

Transmitted herewith is an Amendment in the above-identified application.

The fee has been calculated as shown below.

	Claims After Amendment		Highest Previously Paid For	Present Extra	Small Entity Rate Fee	Large Entity Rate Fee
Total Claims	16	MINUS	20	0	x 9 =	x 18 = \$-0-
Independent Claims	2	MINUS	3	0	x 42 =	x 84 = \$-0-
Multiple Dependent Claim Present and Fee Not Previously Paid					\$140.00	\$280.00
				Total	\$	\$-0-

Applicant(s) hereby petition for a month extension(s) of time to respond to the
aforementioned Office Action.
Applicant(s) believe that no (additional) Extension of Time is required; however, if it is
determined that such an extension is required, Applicant(s) hereby petition that such an extension
be granted and authorize the Commissioner to charge the required fees for an Extension of Time
under 37 CFR 1.136 to Deposit Account No. 50-0388 (Order No. LAM1P147).
Enclosed is our Check No in the amount of \$ to cover the additional
claim fee and/or extension of time fees.
Please charge the required fees, or any additional fees required to facilitate filing the
enclosed response, to Deposit Account No. 50-0388 (Order No. LAM1P147).

Respectfully submitted, BEYER WEAVER & THOMAS, LLP

mihay Loc

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PATENT 7 /3/02

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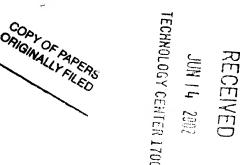
Signed:

Sue Funchess

AMENDMENT A

Box Non-Fee Amendment Commissioner for Patents Washington, D.C. 20231

Dear Sir:



In response to the Office Action dated February 26, 2002, please amend the above-identified patent application as follows:

In the Claims:

Please cancel claims 5 and 7 and amend claims 1, 2, 6, and 8-10 as follows:

- (Once Amended) A method for etching a feature in an integrated circuit wafer, the
 wafer incorporating at least one <u>silicon-free</u> low-k dielectric layer, the method comprising:
 disposing the wafer within a reaction chamber;
 introducing a flow of fluorocarbon-containing etchant gas into the reaction chamber;
 forming a plasma from the etchant gas within the reaction chamber; and
 etching the feature in at least a portion of the <u>silicon-free</u> low-k dielectric layer.
- 2. (Once Amended) The method, as recited in claim 1, wherein the <u>silicon-free</u> low-k dielectric layer is an organic <u>silicon-free</u> benzocyclobutene low-k dielectric layer.